

FDB0105N407L N-Channel PowerTrench[®] MOSFET

FDB0105N407L N-Channel PowerTrench[®] MOSFET 40 V, 460 A, 0.8 m Ω

Features

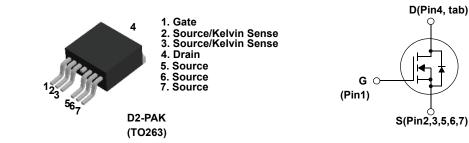
- Max r_{DS(on)} = 0.8 mΩ at V_{GS} = 10 V, I_D = 50 A
- Max $r_{DS(on)}$ = 1.1 m Ω at V_{GS} = 6 V, I_D = 42 A
- Fast Switching Speed
- Low Gate Charge
- \blacksquare High Performance Trench Technology for Extremely Low $R_{DS(on)}$
- High Power and Current Handling Capability
- RoHS Compliant

General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench[®] process that has been especially tailored to minimize the on-state resistance while maintaining superior ruggedness and switching performance for industrial applications.

Applications

- Industrial Motor Drive
- Industrial Power Supply
- Industrial Automation
- Battery Operated tools
- Battery Protection
- Solar Inverters
- UPS and Energy Inverters
- Energy Storage
- Load Switch



MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted.

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			40	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25°C	(Note 5)	460		
Ι _D	-Continuous	T _C = 100°C	(Note 5)	330	Α	
	-Pulsed (Note			2540		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	1109	mJ	
P _D	Power Dissipation $T_{\rm C} = 25^{\circ}{\rm C}$			300	w	
	Power Dissipation $T_A = 25^{\circ}C$ (Note 1a)		(Note 1a)	3.8	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +175	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	0.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	40	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB0105N407L	FDB0105N407L	D2-PAK-7L	330mm	24mm	800 units

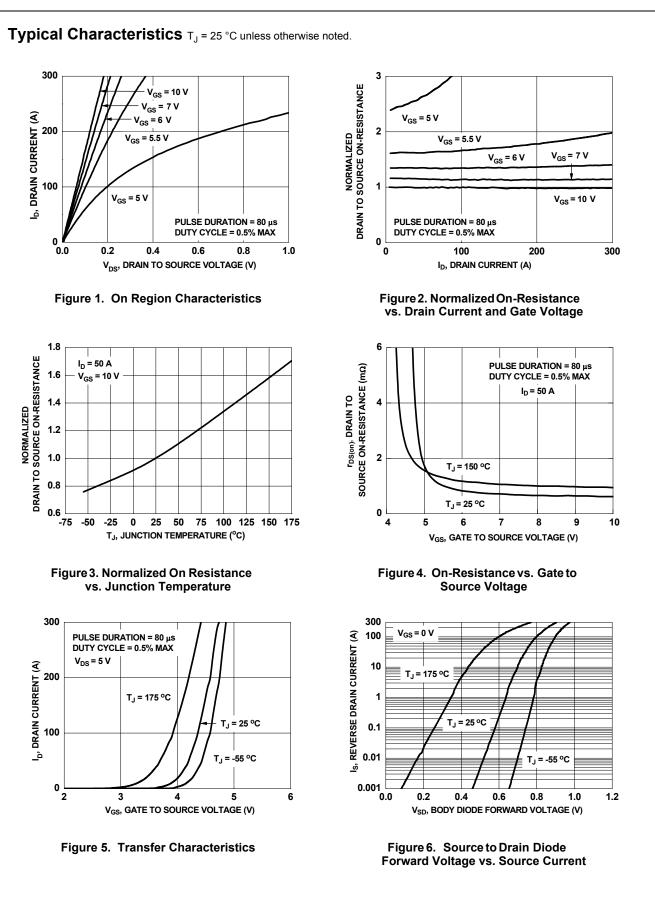
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chara	acteristics				I	
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	40			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		13		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 32 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V			±100	nA
On Chara	octeristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	2	2.8	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-9		mV/°C
r _{DS(on)}	Statia Dazia ta Causas On Desistence	V _{GS} = 10 V, I _D = 50 A		0.6	0.8	
	Static Drain to Source On Resistance	V _{GS} = 6 V, I _D = 42 A		0.8	1.1	mΩ
		V_{GS} = 10 V, I _D = 50 A, T _J = 150°C		1	1.8	
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 50 A		286		S
C _{iss} C _{oss}	Characteristics Input Capacitance Output Capacitance	V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz		16500 5335	23100 7470	pF pF
C _{rss}	Reverse Transfer Capacitance			973	1365	pF
Rg	Gate Resistance			2.6		Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			45	73	ns
t _r	Rise Time	V _{DD} = 20 V, I _D = 50 A,		69	110	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		117	186	ns
t _f	Fall Time			61	97	ns
Q _g	Total Gate Charge			208	291	nC
Q _{gs}	Gate to Source Gate Charge	$V_{DD} = 20 \text{ V}, \text{ I}_{D} = 50 \text{ A},$ $V_{GS} = 10 \text{ V}$		64		nC
Q _{gd}	Gate to Drain "Miller" Charge	- V _{GS} - 10 V		29		nC
Drain-Sou	urce Diode Characteristics					
I _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	460	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	2540	Α
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _S = 50 A (Note 2)		0.8	1.2	V
	Reverse Recovery Time			107	171	ns
t _{rr}		— I _F = 50 A, di/dt = 100 A/μs				

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0 %.

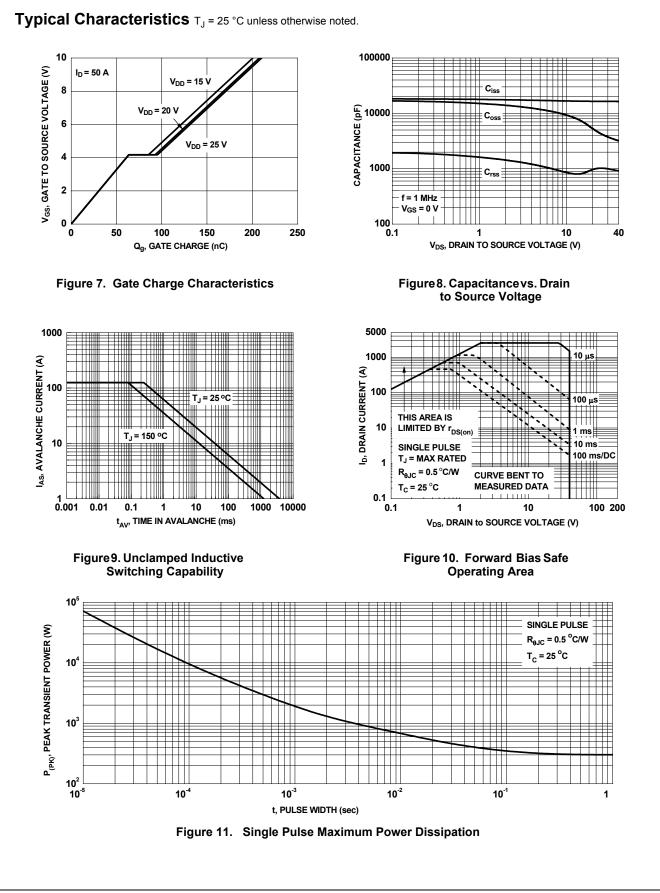
3. E_{AS} of 1109 mJ is based on starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 86 A, V_{DD} = 10 V, V_{GS} = 36 V. 100% test at L = 0.1 mH, I_{AS} = 125 A.

4. Pulsed Id please refer to Figure "Forward Bias Safe Operating Area" for more details.

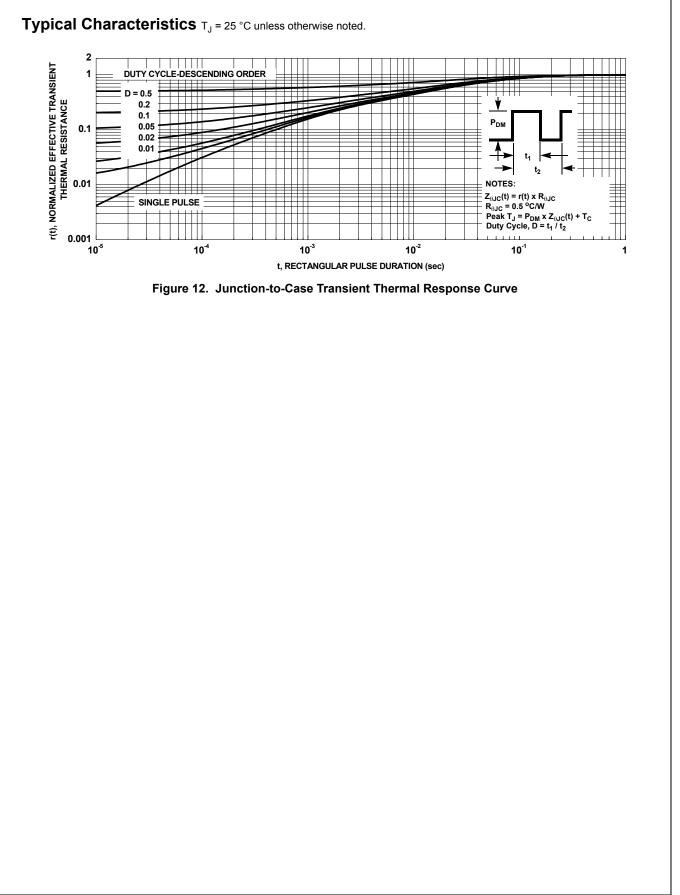
5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

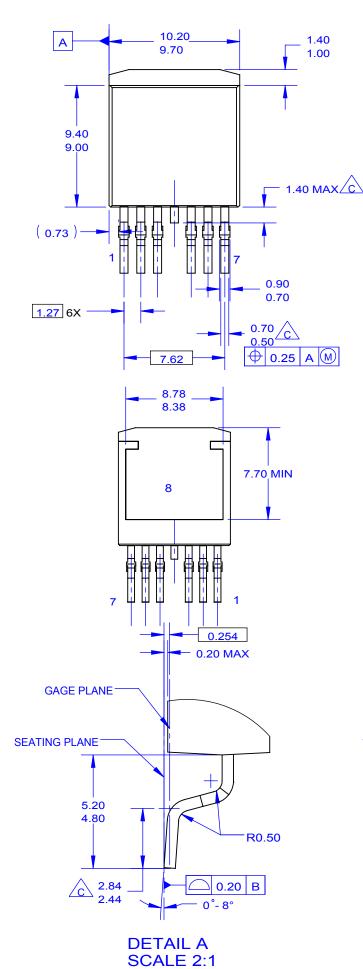


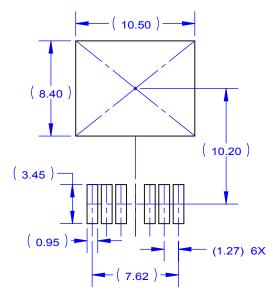
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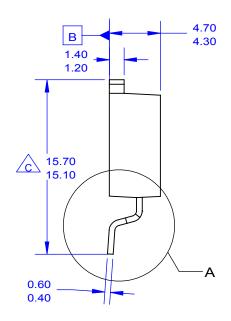
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NOTES:

- A. PACKAGE CONFORMS TO JEDEC TO-263 VARIATION CB EXCEPT WHERE NOTED.
 B. ALL DIMENSIONS ARE IN MILLIMETERS.
- OUT OF JEDEC STANDARD VALUE. D. DIMENSION AND TOLERANCE AS PER ASME
 - Y14.5-1994. E. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
 - F. LAND PATTERN RECOMMENDATION PER IPC. TO127P1524X465-8N.
 - G. DRAWING FILE NAME: TO263A07REV5.



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